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**Laser-Induced Selective Deposition on Metal Using Electroless Gold**

by  
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**Editor's Note:** Originally published as H.R. Khan, M.U. Kittel and Ch. J. Raub, *Plating and Surface Finishing*, **75 (8)**, 58-64 (1988), this paper was awarded the 1989 AESF Gold Medal for Best Paper published in *Plating and Surface Finishing* in 1988.

**ABSTRACT**

*Gold is selectively deposited on thin layers of nickel and silver on epoxy resin plates using electroless gold baths of various stabilities and a focused beam from an argon-ion laser. The effects of laser-beam intensity, substrate material, layer thickness and electrolyte stability on deposition and electrode potential were investigated. Deposit morphology was studied by scanning electron microscopy and compared with the morphology of deposits from electroless baths heated to 80°C without laser irradiation.*

**Introduction**

Laser-induced selective metal deposition on metallic and non-metallic substrates has been the subject of much attention recently. An induced deposition rate several orders of magnitude greater than conventional rates is claimed to occur at points where a laser beam impinges the electrode surface. Laser-enhanced deposition of nickel, copper, gold and palladium from electroless baths has been reported,<sup>1-6</sup> with the increased plating rate at the point of the laser beam attributed to heating of the electrolyte/electrode interface, increased convection and electrochemical changes.

This technique seems promising for precious metal contact and microelectronic applications because it works well on small, localized areas, does not require masking, and provides high deposition rates. The results of a study on laser-induced electroless gold deposition on thin layers of silver and nickel on an epoxy resin substrate are reported in this paper.

**Experimental procedure**

An argon-ion laser of variable power (1 to 5 watts) was focused on the substrate in an electrolyte. The power density at the electrode was several kW/cm<sup>2</sup>. The substrate was close to the beam, generating a gold deposit of about 100 to 160 μm in diameter. Details of the laser system are described elsewhere.<sup>7</sup>

**Table 1** - Electroless baths used for laser-enhanced deposition.

<b>Bath no.*</b>	<b>KOH conc., g/L</b>	<b>KCN conc., g/L</b>	<b>KAu(CN)<sub>2</sub> conc., M</b>	<b>Stability</b>
EL1	10	15	0.003	Medium
EL2	5	5	0.003	Least
EL3	10	15	0.006	Most

\*All solutions contained 17 g/L K(BH<sub>4</sub>).

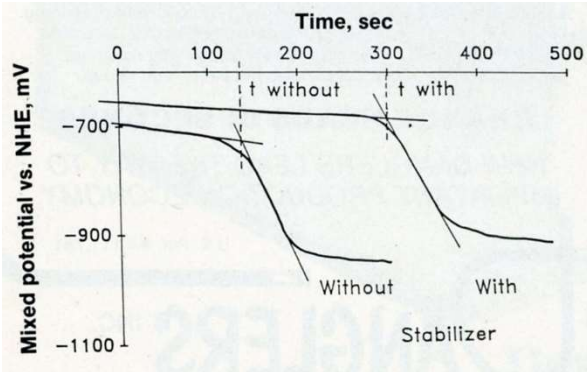
Three electroless gold solutions (Table 1) with varying amounts of KOH, KCN, K[Au(CN)<sub>2</sub>] and K(BH<sub>4</sub>) were used. The chemical composition of the baths is one stability-determining factor. Stability was measured using a method developed by the authors.<sup>8-10</sup> The mixed potential vs. time was measured after a decomposition-causing solution was added to the operational electrolyte. In this type of electrolyte, the mixed potential/time curve jumps quickly to more negative values once precipitation of the metals begins. Depending on the type of electrolyte, addition

agents and bath condition, decomposition will be delayed when compared to a freshly prepared reference electrolyte with or without additives. Typical curves and the effect of a stabilizer are shown in Fig. 1. As a measure of stability (S), time  $t_{\text{with}}$ :time  $t_{\text{without}}$  a stabilizer is a convenient ratio. Stable baths have high S values, whereas unstable baths exhibit low values.

The surface of 1-mm-thick plates of epoxy resin (1×2 cm) was activated by a Pd-Sn solution before being electroplated with 2-, 10-, or 20-μm-thick layers of silver or nickel prior to gold deposition. Samples were exposed to a laser beam for a period of 2 min in the electrolyte. Changes in the electrode (substrate) potential were recorded against a standard calomel electrode (SCE) and

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later corrected against a normal hydrogen electrode (NHE). Deposit morphology was investigated using a scanning electron microscope.

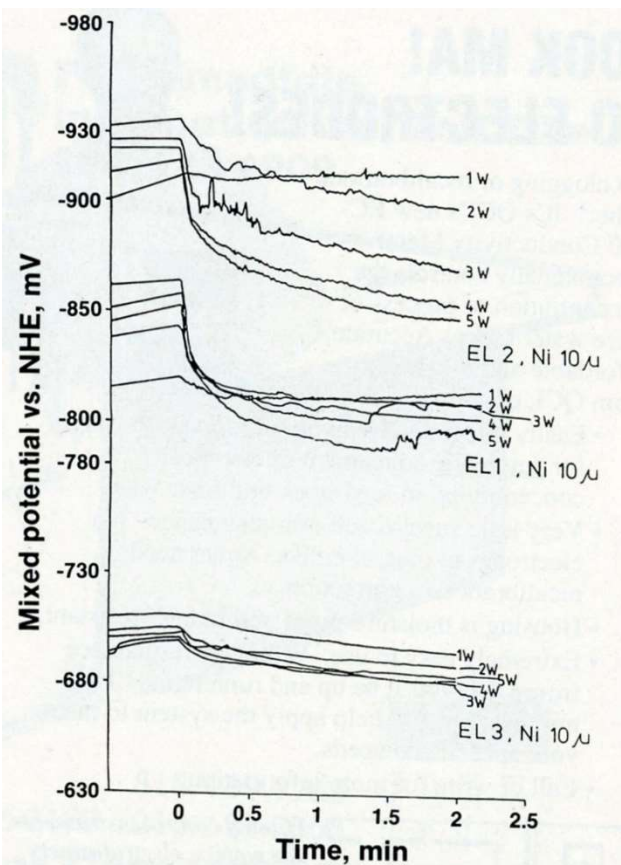


**Figure 1** - Typical potential-vs.-time curve for an electroless gold bath with and without stabilizer.

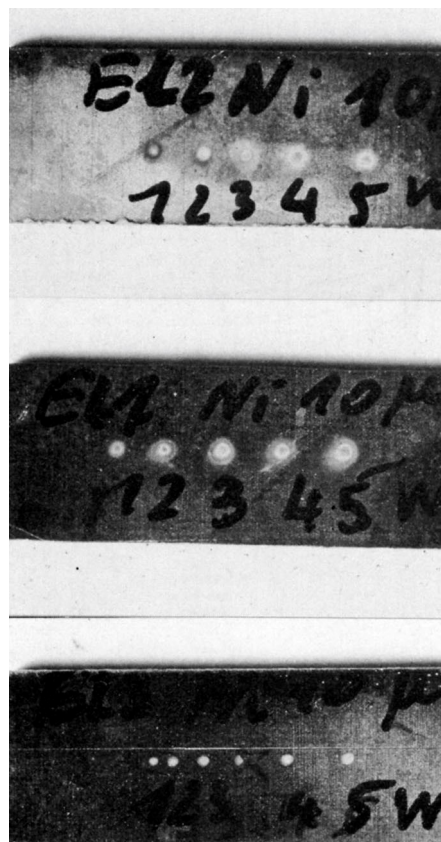
**Gold over nickel**

The variation of electrode potentials as a function of time during the laser-induced deposition of gold on 10- $\mu$ -thick nickel is shown in Fig. 2. Three electrolytes (baths) at five laser power levels (1 to 5 W) were used. The electrode potential increased as bath stability increased and decreased as laser power increased. Figure 3 shows the laser-induced gold deposits from three baths; the edge sharpness of the deposits increased with increased bath stability as long as the thickness of the substrate remained constant.

The edges of the gold deposits from the most stable bath (EL3) were very sharp (Fig. 3c); gold was deposited only on the area directly exposed to the laser beam.



**Figure 2** - Mixed potential as a function of time for laser-induced gold deposition from Baths EL1, EL2 and EL3 (the most stable) on 10- $\mu$ -thick nickel.

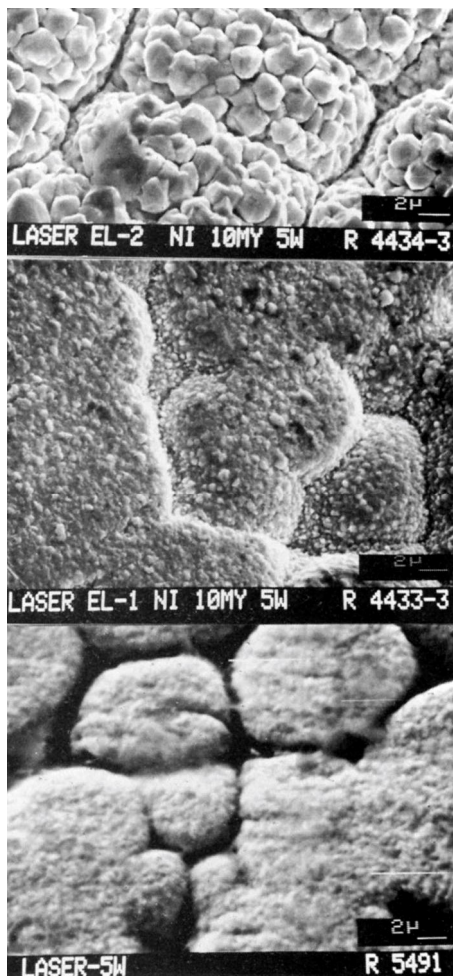


**Figure 3** - Photos of laser-induced (at 1 to 5 W) gold deposits from (a) Bath EL2, (b) Bath EL1, and (c) Bath EL3 on 10- $\mu$ -thick nickel on epoxy. Magnification was 29 $\times$ , 25 $\times$  and 33 $\times$  for Deposits a-c, respectively.

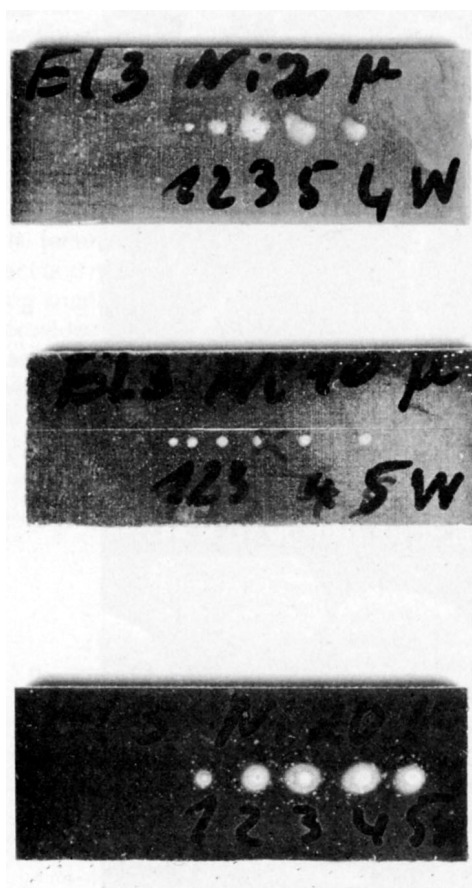
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Figure 4 shows the morphology of the gold deposits at 5 W of laser power. Smaller grains are distributed among the larger grains; the small grains become even finer as bath stability increases.

To study the effect of nickel thickness on gold deposition, the most stable electrolyte, EL3, was chosen for gold plating on 2-, 10-, and 20- $\mu$ m-thick nickel. The gold spots on 2- and 20- $\mu$ m-thick nickel (Figs. 5a and 5c, respectively) were larger than the laser-beam points; this fact was attributed to lateral spreading of the heat generated by the laser beam. For the 10- $\mu$ m-thick nickel, gold deposition was selective and limited to irradiated areas (Fig. 5b). The electrode potentials for 10- $\mu$ m-thick nickel were less negative than those for 2- or 20- $\mu$ m-thick nickel (Fig. 5).



**Figure 4** - SEMs (3500 $\times$ ) of laser-induced (at 5 W) gold deposits from (a) Bath EL2, (b) Bath EL1 and (c) Bath EL3 on 10- $\mu$ m-thick nickel on epoxy.



**Figure 5** - Photos (34 $\times$ ) of laser-induced (at 1 to 5 W) gold deposits from the three baths on (a) 2  $\mu$ m of Ni, (b) 10  $\mu$ m of Ni, and (c) 20  $\mu$ m of nickel.

Bath EL3 was also used to study mixed electrode potential as a function of time. Figure 6 shows that the mixed potential in the most stable bath is less negative over 10  $\mu$ m of nickel than over 2 or 20  $\mu$ m.

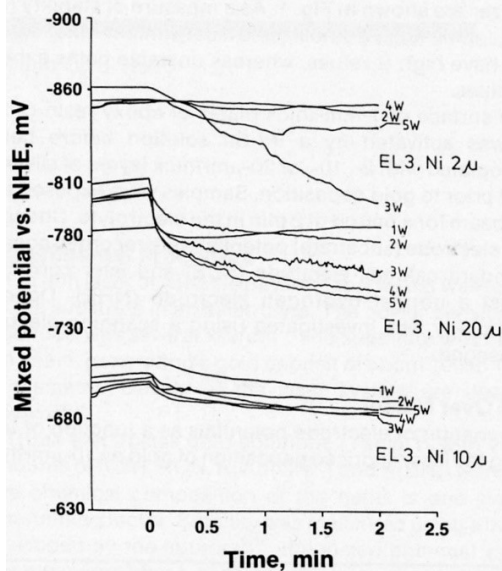
**Gold over Silver**

Figure 7 presents electrode-potential data for gold over silver. The curves are similar to those for gold over nickel. The electrode potential in the most stable electrolyte (EL3) is less negative than the potentials in the other solutions.

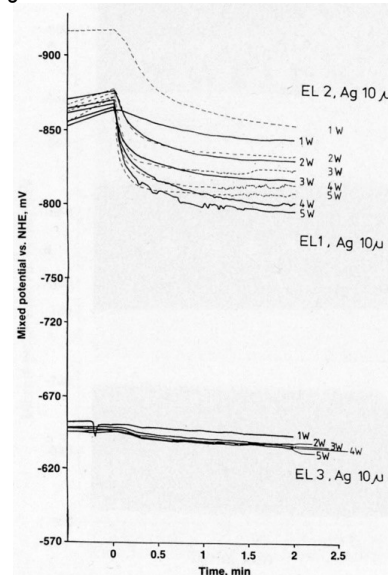
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All the laser-induced gold deposits on 10- $\mu$ m-thick silver layers from three different electrolytes had a thin layer of gold outside the directly laser-irradiated gold spots (Figs. 8a-c). The deposition rate on silver was much higher than that on nickel, and the gold spots were about three times larger on silver than on nickel. This spreading of spots can be explained by the greater thermal conductivity of the silver. Bath EL3, which produced the sharpest gold deposits on nickel, produced no gold deposit on silver. Figure 9 shows that gold deposited on silver from Bath EL1 had finer grains than those from Bath EL2.



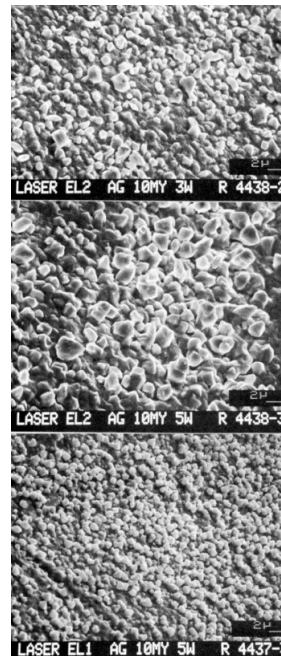
**Figure 6** - Mixed potential as a function of time for laser-induced gold deposition from Bath EL3 on 2-, 10-, and 20- $\mu$ m-thick nickel.



**Figure 7** - Mixed potential as a function of time during laser-induced gold deposition on 10- $\mu$ m-thick silver.



**Figure 8** - Photos of laser-induced (at 1 to 5 W) gold deposits from (a) Bath EL2, (b) Bath EL1, and (c) Bath EL3 on 10- $\mu$ m-thick silver. Magnification was 27 $\times$ , 20 $\times$ , and 31 $\times$  for Deposits a-c, respectively.



**Figure 9** - SEMs of gold deposited on 10- $\mu$ m-thick silver on epoxy using (a) Bath EL2 and 3 W of laser power, (b) Bath EL2 and 5 W, and (c) Bath EL1 and 5 W.

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### Effect of laser power

The electrode potential became less negative as the laser power was increased from 1 to 5 watts (Fig. 2); the size of the gold spot also increased as the power increased. However, the difference between the starting and final electrode potentials ( $E_s - E_f$ ) became smaller with increasing bath stability.

Tables 2-4 list starting potentials at time = 0 (laser turned off), final potentials after 2 min of irradiation, the difference between potentials at time = 0 and time = 2, and the difference between potentials after irradiation at various wattages. A comparison of the data in Tables 2-4 with SEMs of the gold deposits reveals that there is no direct relationship between the laser wattage used and the structure of the deposits.

**Table 2 - Electrode potentials for 10  $\mu\text{m}$ -thick nickel layers.<sup>a</sup>**

Bath no.	Laser power, W	Starting potential	Final potential	$E_s - E_f$ ( $\Delta E$ ), <sup>d</sup> mV	$E_{t1} - E_{t5}$ , <sup>e</sup> mV
		( $E_s$ ), <sup>b</sup> mV vs. NHE	( $E_f$ ), <sup>c</sup> mV vs. NHE		
EL1	1	-907	-910	3	65
	2	-933	-895	38	
	3	-923	-866	57	
	4	-919	-851	68	
	5	-913	-845	68	
EL2	1	-817	-811	6	17
	2	-860	-806	54	
	3	-854	-806	48	
	4	-849	-801	48	
	5	-840	-794	46	
EL3	1	-709	-696	13	10
	2	-704	-690	14	
	3	-702	-682	20	
	4	-699	-684	15	
	5	-698	-685	13	

<sup>a</sup>Gold deposits in Fig. 2.

<sup>b</sup> $t=0$  (laser turned off);  $t$  represents time.

<sup>c</sup> $t=2$  min.

<sup>d</sup>Difference between potentials at  $t=0$  and  $t=2$  min.

<sup>e</sup>Difference between potentials at 1 and 5 W of laser power.

**Table 3 - Electrode potentials in Bath EL3 for nickel layers.<sup>a</sup>**

Ni thickness, $\mu\text{m}$	Laser power, W	Starting potential	Final potential	$E_s - E_f$ ( $\Delta E$ ), <sup>d</sup> mV	Potential diff., mV
		( $E_s$ ), <sup>b</sup> mV vs. NHE	( $E_f$ ), <sup>c</sup> mV vs. NHE		
2	2	-857	-844	13	9 <sup>e</sup>
	3	-850	-796	54	
	4	-850	-848	2	
	5	-849	-835	14	
20	1	-799	-783	16	40 <sup>e</sup>
	2	-803	-775	28	
	3	-799	-759	40	
	4	-808	-748	50	
	5	-782	-743	39	
10	1	-709	-696	13	11 <sup>f</sup>
	2	-704	-690	14	
	3	-702	-682	20	
	4	-699	-684	15	
	5	-698	-685	13	

<sup>a</sup>Gold deposits in Fig. 6

<sup>b</sup> $t=0$  (laser turned off);  $t$  represents time.

<sup>c</sup> $t=2$  min.

<sup>d</sup>Difference between potentials at  $t=0$  and  $t=2$  min.

<sup>e</sup>Difference between potentials at 2 and 5 W of laser power.

<sup>f</sup>Difference between potentials at 4 and 5 W.

<sup>g</sup>Difference between potentials at 1 and 2 W.

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**Table 4 - Electrode potentials for 10  $\mu\text{m}$ -thick silver layers.<sup>a</sup>**

Bath no.	Laser power, W	Starting potential (E <sub>i</sub> ), <sup>b</sup> mV vs. NHE	Final potential (E <sub>f</sub> ), <sup>c</sup> mV vs. NHE	E <sub>i</sub> -E <sub>f</sub> ( $\Delta E$ ), <sup>d</sup> mV	E <sub>1</sub> -E <sub>5</sub> , <sup>e</sup> mV
EL1	1	-910	-849	61	45
	2	-873	-828	45	
	3	-869	-809	50	
	4	-867	-804	58	
	5	-867	-804	63	
EL2	1	-857	-840	17	48
	2	-871	-825	46	
	3	-860	-813	47	
	4	-862	-797	65	
	5	-865	-792	73	
EL3	1	-649	-642	7	10
	2	-647	-637	10	
	3	-645	-635	10	
	4	-643	-635	8	
	5	-643	-632	11	

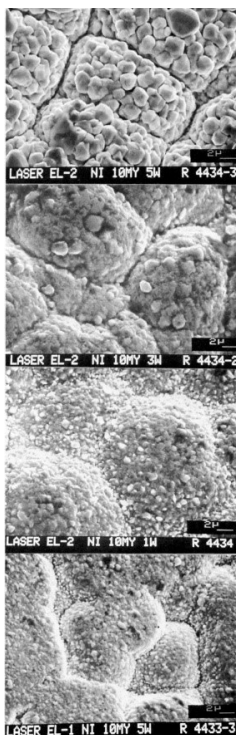
<sup>a</sup>Gold deposits in Fig. 6.

<sup>b</sup>t=0 (laser turned off); t represents time.

<sup>c</sup>t=2 min.

<sup>d</sup>Difference between potentials at t=0 and t=2 min.

<sup>e</sup>Difference between potentials at 1 and 5 W of laser power.



**Figure 10 - SEMs (3500 $\times$ ) of gold deposited on 10- $\mu\text{m}$ -thick nickel on epoxy using (a) Bath EL2 and 5 W of laser power, (b) Bath EL2 and 3 W, (c) Bath EL2 and 1 W, and (d) Bath EL1 and 1 W.**

The change in potential after turning on the laser (*i.e.*, the gradient of the electrolyte potential between ambient and laser temperature) does not seem to be critical. More important is the gradient in the higher temperature range (80 to 150°C) generated by 5 W of laser power.<sup>12</sup> This gradient is a measure of the activity of the gold-deposition process in the electroless bath. Furthermore, the formation of "thermal batteries" during laser heating of the cathode and the change in the active surface (from nickel or silver to gold) must be considered. Application of a small potential before irradiation had little effect on deposits under the conditions investigated.

The microstructure of the gold deposits on 10- $\mu\text{m}$ -thick nickel layers is shown in Figs. 10a-d. The grain size of the deposits decreased with lower laser wattages because the rate of deposition was slow compared to the rate obtained with higher wattages.

Figure 11 shows the structure of electroless gold from Bath EL1, which contained 15 g/L KCN and was heated to 80°C by conventional methods rather than by a laser beam. The deposit has a fine, needle-like structure, whereas the laser-induced deposit from the same electrolyte contained small cubic particles (Fig. 9c). When the concentration of KCN in the 80°C electroless bath was reduced to 10 g/L, the deposit structure (Fig. 12) resembled that in Fig. 9c.

From this study, the authors concluded that in electroless gold baths, the chemistry of the bath and the heating of the cathode and/or the cathodic layer have a dominant effect on deposition.

### Discussion

Deposition mechanisms of electroless gold electrolytes have been discussed extensively in the literature,<sup>11</sup> but a complete understanding of the process still eludes researchers. The electrolyte certainly is kept in a metastable condition by addition agents in order to prevent decomposition.

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**Figure 11** - SEM of gold deposited from Bath EL1 (15 g/L KCN, 80°C) on silver.



**Figure 12** - SEM of gold deposited from Bath EL1 (10 g/L KCN, 80°C) on silver.

Temperatures in excess of established operating temperatures will enhance the decomposition rate, or nuclei formation and growth, especially if catalysis at activated sites on the substrate is no longer inhibited. Laser irradiation thus provides energy for the reduction reaction, increases the diffusion rate of ions to growth sites, and accelerates surface diffusion. These are processes that promote grain growth; a coarse structure is formed at higher laser wattages on low-heat-conducting substrates. Unexplainable complications occur when stabilizer molecules are adsorbed on nucleation sites or growth planes; in general, adsorption decreases at high temperatures.

However, no definite predictions can be made for these gold electrolytes with Au-Co solutions.<sup>12</sup> There was no continuous increase in grain size with temperature. The largest grains were observed at 90°C; grains were smaller when either higher or lower process temperatures were used. The adsorption maxima of either additives (stabilizers) or the decomposition products of electrolyte constituents certainly may play a role in the complicated interplay between nuclei formation and growth. In general, nuclei growth is promoted by higher temperatures and reduced by the use of appropriate additives.

An interesting topic for future work might be a study of the role of AuCN in electroless gold baths.

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